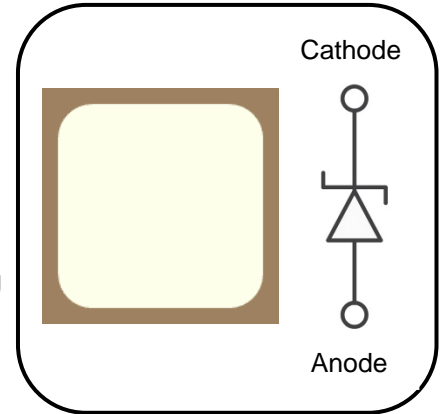


3rd Generation 650V/10A SiC Schottky Barrier Diode

Features

- AEC-Q101 qualified
- Revolutionary semiconductor material - Silicon Carbide (SiC)
 - No reverse recovery
 - High-speed switching performance
 - Temperature-independent switching behavior
 - System cost / size savings due to reduced cooling requirements
- Junction temperature range from -55°C to 175°C
- RoHS compliant



Applications

- DC/DC converter for EV/HEV
- On board charger (OBC)



Description

The ADS065J010B3 SiC Schottky Barrier Diode (SBD) has been developed using Sanan’s advanced 3rd generation SiC SBD technology with the highest performance and reliability. It registers higher efficiency, higher operation temperature and lower loss and can be operated at higher frequency than Si-based solutions. As to the Schottky structure, it shows no recovery at turn-off and allows a low leakage current with reverse voltage up to 650V. It can contribute to system miniaturization and achieve lightweight system design. Using RoHS compliant components and being AEC-Q101 qualified, it is qualified for use in automotive application.

Product Specifications

Device	V_{RRM}	$I_F (135^\circ C)$	$V_F (25^\circ C)$	Q_C
ADS065J010B3	650V	15A	1.30V	29nC

CONTENTS

Features.....	1
Applications	1
Description	1
Product Specifications	1
Table 1. Maximum Ratings	3
Table 2. Thermal Resistance	3
Table 3. Static Electrical Characteristics	4
Table 4. Dynamic Electrical Characteristics	4
Electrical Characteristic Diagrams.....	5
Ordering Information	6
Important Notices – Read Carefully	7
Warning.....	7

Table 1. Maximum Ratings

(T_c = 25°C, unless otherwise specified)

Parameter	Symbol	Value	Unit	Test conditions
Repetitive peak reverse voltage	V _{RRM}	650	V	T _C = 25°C
Surge peak reverse voltage	V _{RSM}	650		T _C = 25°C
DC reverse voltage	V _{DC}	650		T _C = 25°C
Continuous forward current	I _F	30	A	T _C = 25°C
		15		T _C = 135°C
		10		T _C = 150°C
Surge non-repetitive forward current	I _{FSM}	80	A	T _C = 25°C, t _p = 10ms, half sine pulse
Repetitive peak forward current	I _{FRM}	54	A	T _C = 25°C, t _p = 10ms, half sine wave D = 0.1
i ² t value	∫i ² dt	32	A ² s	T _C = 25°C, t _p = 10ms
Operating junction temperature	T _j	-55~175	°C	
Storage temperature	T _{stg}	-55~175	°C	

Table 2. Thermal Resistance

Parameter	Symbol	Values			Unit	Test condition
		Min.	Typ.	Max.		
Thermal resistance from junction to case	R _{th(j-c)}	/	1.24	/	°C/W	

*Thermal Resistance is collected in TO220-2L

Table 3. Static Electrical Characteristics

(Tc = 25°C, unless otherwise specified)

Parameter	Symbol	Values			Unit	Test conditions
		Min.	Typ.	Max.		
DC blocking voltage	V _{DC}	650	/	/	V	I _R = 100 μA
Forward voltage	V _F	/	1.30	1.50	V	I _F = 10A, T _j = 25°C
		/	1.55	1.80		I _F = 10A, T _j = 175°C
Reverse current	I _R	/	1	30	μA	V _R = 650V, T _j = 25°C
		/	3	80		V _R = 650V, T _j = 175°C

Table 4. Dynamic Electrical Characteristics

(Tc = 25°C, unless otherwise specified)

Parameter	Symbol	Values			Unit	Test conditions
		Min.	Typ.	Max.		
Total capacitance	C	/	556	/	pF	V _R = 0V, f = 1MHz
		/	55	/		V _R = 200V, f = 1MHz
		/	45	/		V _R = 400V, f = 1MHz
Total capacitive charge	Q _C	/	29	/	nC	V _R = 400V
Capacitance stored energy	E _C	/	4.3	/	μJ	V _R = 400V

Electrical Characteristic Diagrams

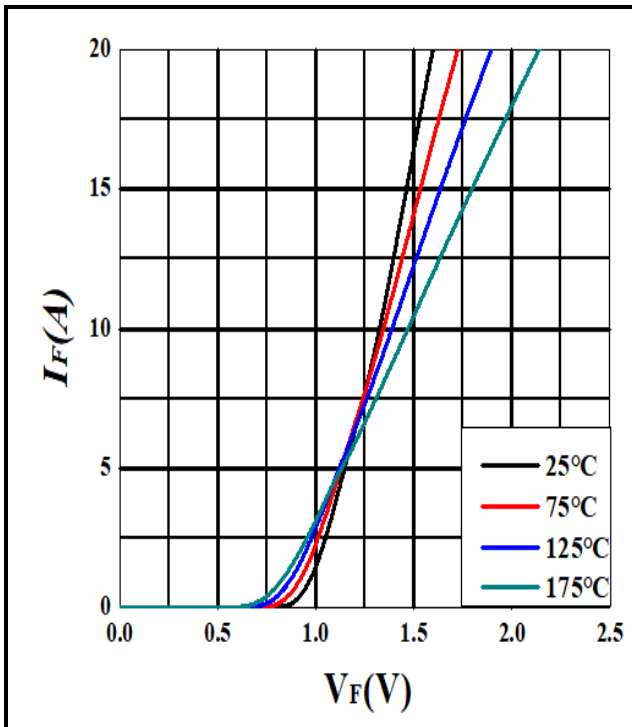


Figure 1. Forward characteristics

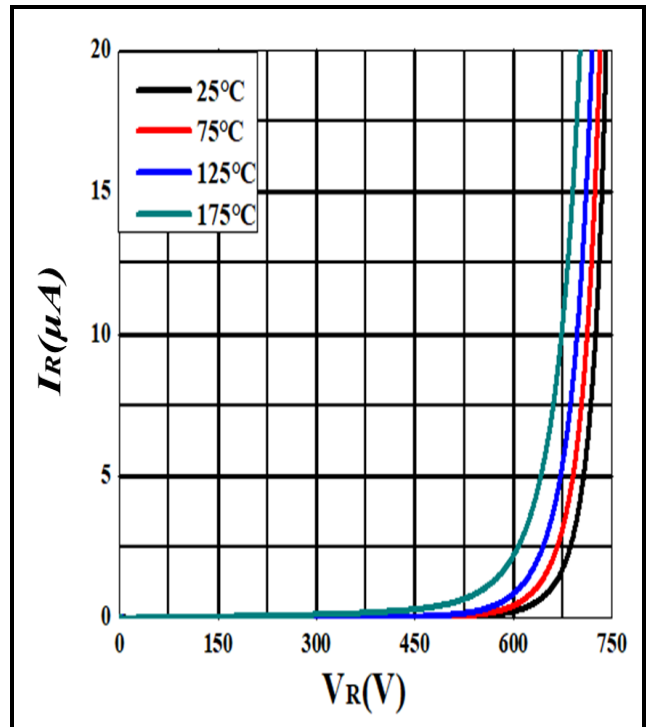


Figure 2. Reverse characteristics

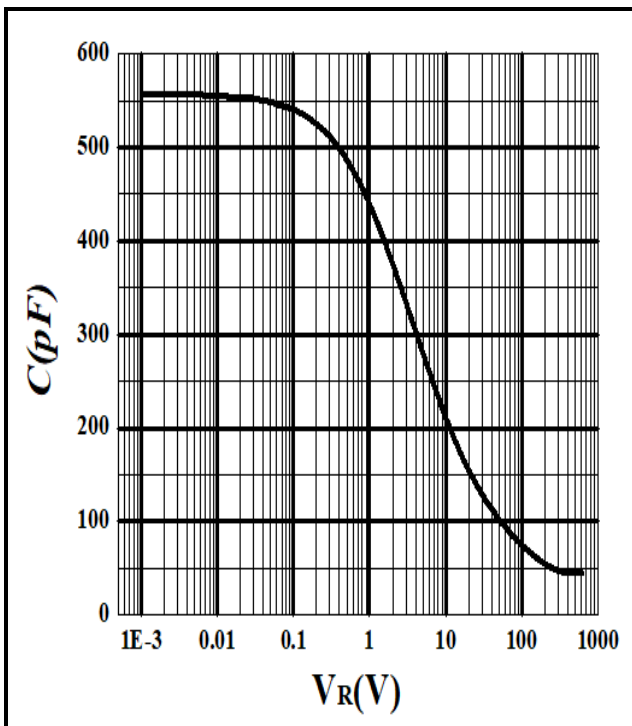


Figure 3. Capacitance vs. reverse voltage

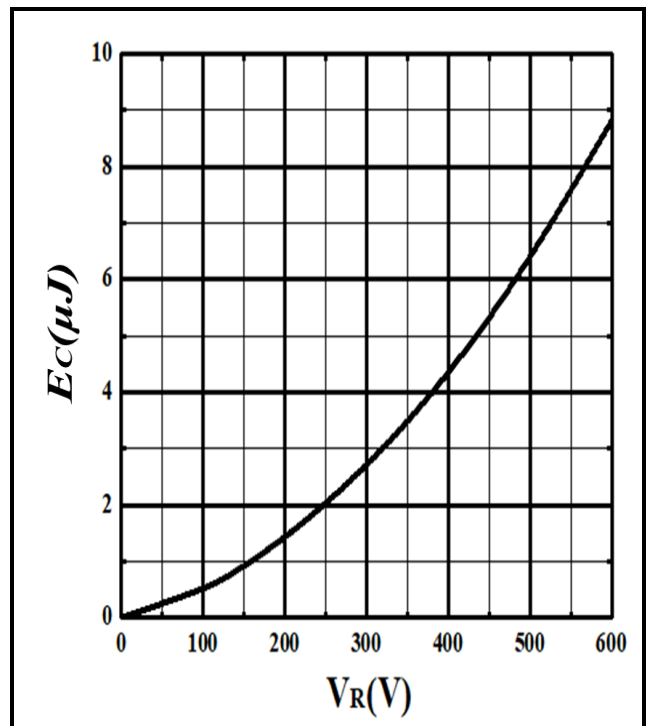


Figure 4. Capacitance stored energy

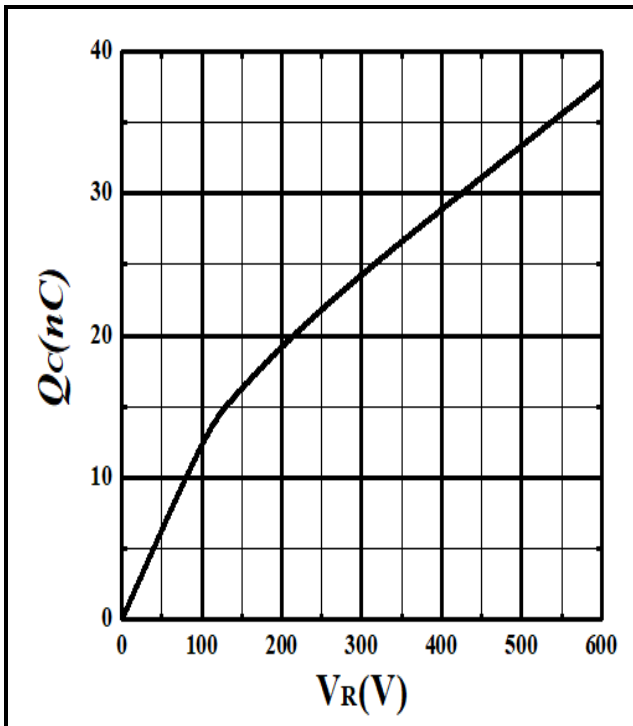


Figure 5. Total capacitance charge vs. reverse voltage

Ordering Information

Part number	ADS065J010B3
Package	Bare Die
Packing type	Wafer
RoHS	Yes

Important Notices – Read Carefully

Before you use our products, you are requested to carefully read this document and fully understand its contents. Sanan Semiconductor Co., Ltd. shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of Sanan's products.

Sanan Semiconductor Datasheets are subject to change. Information presented in this document is from the characterization of engineering lots. Sanan reserves the right to change limits, test conditions, and dimensions without notice. Information contained in this document are typical values and shall in no event be regarded as a guarantee of characteristics. With respect to any information regarding the application of the product, Sanan hereby disclaims all warranties and liabilities of any kind. The information in this document is exclusively for trained technical staff. It is the responsibility of the customer's technical department to decide the suitability of the product in the customer's application and Sanan assumes no responsibility or liability whatsoever for the use of the information contained in this document.

In case there is any clause in this document or in any other documents which is contradictory to this clause, this clause shall prevail. This clause shall survive after termination of this document.

Warning

Due to technical requirements, Sanan products may contain dangerous substances. For detailed information about the substance(s), please contact the Sanan office. Sanan bears no responsibility for any damage whatsoever due to the substance(s) used in Sanan products.

Contact info

Website: <https://www.sanan-semiconductor.com/>
<https://www.sanan-semiconductor.com/en>